

Symbol	Component	Numerical value	Connection	Remarks(Model No.)
C_VM1	Electrolytic capacitor	100uF	○	50V pressure-resistant
C_VM2	Ceramic capacitor or chip capacitor	0.1uF	○	
C_VDD	Electrolytic capacitor	10uF	○	
C_VREF	Ceramic capacitor or chip capacitor	0.1uF	○	
C_VDD	Electrolytic capacitor	10uF	○	10V pressure-resistant
R_RSA	Chip resistance	0.22Ω		
R_RSB	Chip resistance	0.22Ω		
R_OSC	Chip resistance or lead resistance	47kΩ	○	
R_VREF1	Chip resistance or lead resistance	50kΩ	○	$V_{REF} = V_{DD} \times R_{VREF2} / (R_{VREF1} + R_{VREF2})$ (Refer to TD for current calculation formula)
R_VREF2	Chip resistance or lead resistance	30kΩ	○	
R_LO1	Chip resistance or lead resistance	10kΩ	○	
R_LO2	Chip resistance or lead resistance	10kΩ	○	
R_MO	Chip resistance or lead resistance	10kΩ	○	
SW1~12	Switch		○	ATE1E-2M3-10-Z
CN	Connector		○	
Check pin	Check pin		○	ST-2-3
SR1	Short pattern		○	
SR2	Short pattern		○	

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